





#### **General Description**

The WSL220N08 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSL220N08 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

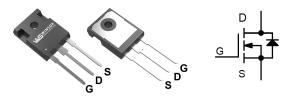
#### **Product Summery**

BVDSS	RDSON	ID
85V	4.9mΩ	210A

#### Applications

- High Frequency Point-of-Load Synchronous
  Buck Converter
- Networking DC-DC Power System

#### **TO-247 Pin Configuration**



### **Absolute Maximum Ratings**

Parameter		Rating	Unit	
Ratings (T <sub>c</sub> =25°C Unless Otherwise Noted)				
Drain-Source Voltage		85	V	
Gate-Source Voltage		±20		
Maximum Junction Temperature		175	°C	
Storage Temperature Range		-55 to 175	°C	
Diode Continuous Forward Current	T <sub>C</sub> =25°C	210	А	
on Large Heat Sink	•		-	
Pulsed Drain Current *	T <sub>C</sub> =25°C	850**	А	
Dentinuero Denia Overent	T <sub>C</sub> =25°C	210		
	T <sub>C</sub> =100°C	150	- A	
	T <sub>C</sub> =25°C	300	10/	
Maximum Power Dissipation	T <sub>C</sub> =100°C	178	- W	
Thermal Resistance-Junction to Case		0.5	°C/W	
Thermal Resistance-Junction to Ambient	63.5			
e Ratings				
Avalanche Energy, Single Pulsed	L=0.5mH	1800***	mJ	
	Drain-Source Voltage Gate-Source Voltage Maximum Junction Temperature Storage Temperature Range Diode Continuous Forward Current <b>on Large Heat Sink</b> Pulsed Drain Current * Continuous Drain Current Maximum Power Dissipation Thermal Resistance-Junction to Case Thermal Resistance-Junction to Ambient <b>Ratings</b> Avalanche Energy, Single Pulsed	Drain-Source Voltage      Gate-Source Voltage      Maximum Junction Temperature      Storage Temperature Range      Diode Continuous Forward Current      Tc=25°C      On Large Heat Sink      Pulsed Drain Current *      Continuous Drain Current      Tc=25°C      Tc=100°C      Tc=100°C      Tc=100°C      Thermal Resistance-Junction to Case      Thermal Resistance-Junction to Ambient      Ratings	Drain-Source Voltage85Gate-Source Voltage $\pm 20$ Maximum Junction Temperature175Storage Temperature Range-55 to 175Diode Continuous Forward Current $T_c=25^{\circ}C$ Pulsed Drain Current * $T_c=25^{\circ}C$ Pulsed Drain Current * $T_c=25^{\circ}C$ Continuous Drain Current $T_c=25^{\circ}C$ Maximum Power Dissipation $T_c=25^{\circ}C$ Thermal Resistance-Junction to Case0.5Thermal Resistance-Junction to Ambient63.5RatingsAvalanche Energy, Single PulsedL=0.5mH1800***	

Note : \* Repetitive rating ; pulse width limited by junction temperatur \*\* Drain current is limited by junction temperature

\*\*\* VD=64V



**N-Ch MOSFET** 

#### Electrical Characteristics (T<sub>J</sub>=25 C, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Static Cha	aracteristics					
$BV_{DSS}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250µA	85	-	-	V
	Zero Gate Voltage Drain Current	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V	-	-	1	^
I <sub>DSS</sub>		T <sub>J</sub> =85°C	-	-	10	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA	2.0	3.2	4.0	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V	-	-	±200	nA
R <sub>DS(ON)</sub> *	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =100A	-	4.0	4.9	mΩ
Diode Cha	aracteristics			-		
V <sub>SD</sub> *	Diode Forward Voltage	I <sub>SD</sub> =100A, V <sub>GS</sub> =0V	-	0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time		-	110	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	-I <sub>SD</sub> =100A, dI <sub>SD</sub> /dt=100A/μs	-	300	-	nC
Dynamic (	Characteristics					
$R_G$	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	3.3	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V,	-	7600	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =25V,	-	720	-	
C <sub>rss</sub>	Reverse Transfer Capacitance	Frequency=1.0MHz	-	346	-	
t <sub>d(ON)</sub>	Turn-on Delay Time		-	23	-	
Tr	Turn-on Rise Time	$V_{DD}=40V, R_{G}=6\Omega,$	-	124	-	ns
t <sub>d(OFF)</sub>	Turn-off Delay Time	- I <sub>DS</sub> =100A, V <sub>GS</sub> =10V,	-	84	-	
T <sub>f</sub>	Turn-off Fall Time		-	78	-	
Gate Cha	rge Characteristics	•		•	•	
Qg	Total Gate Charge		-	140	-	
Q <sub>gs</sub>	Gate-Source Charge	│V <sub>DS</sub> =64V, V <sub>GS</sub> =10V, │I <sub>DS</sub> =100A	-	40	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	57	-	

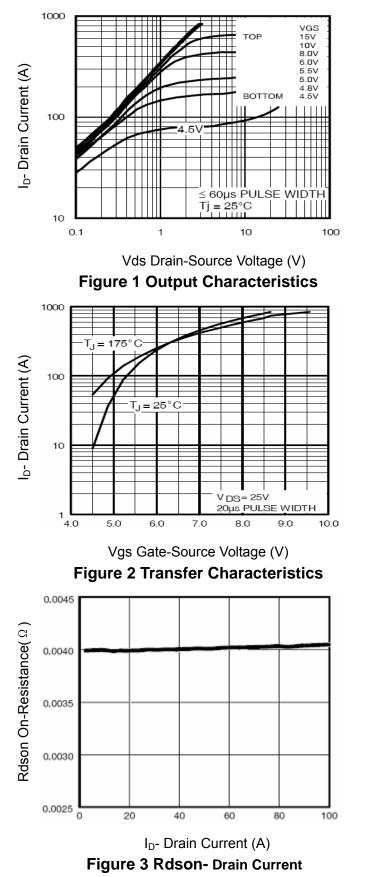
Note \* : Pulse test ; pulse width  $\leq$  300µs, duty cycle  $\leq$  2%.

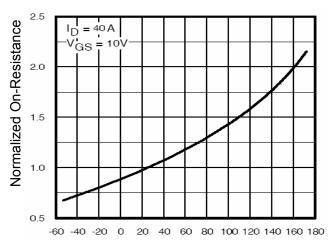
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N-Ch MOSFET

## **Typical Operating Characteristics**





T<sub>J</sub>-Junction Temperature ( $^{\circ}C$ )

#### Figure 4 Rdson-JunctionTemperature

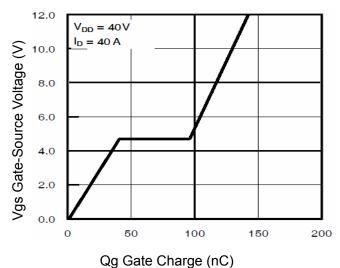
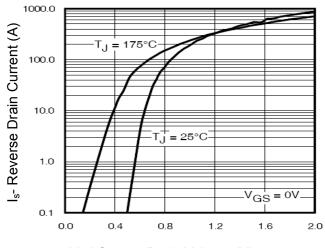


Figure 5 Gate Charge

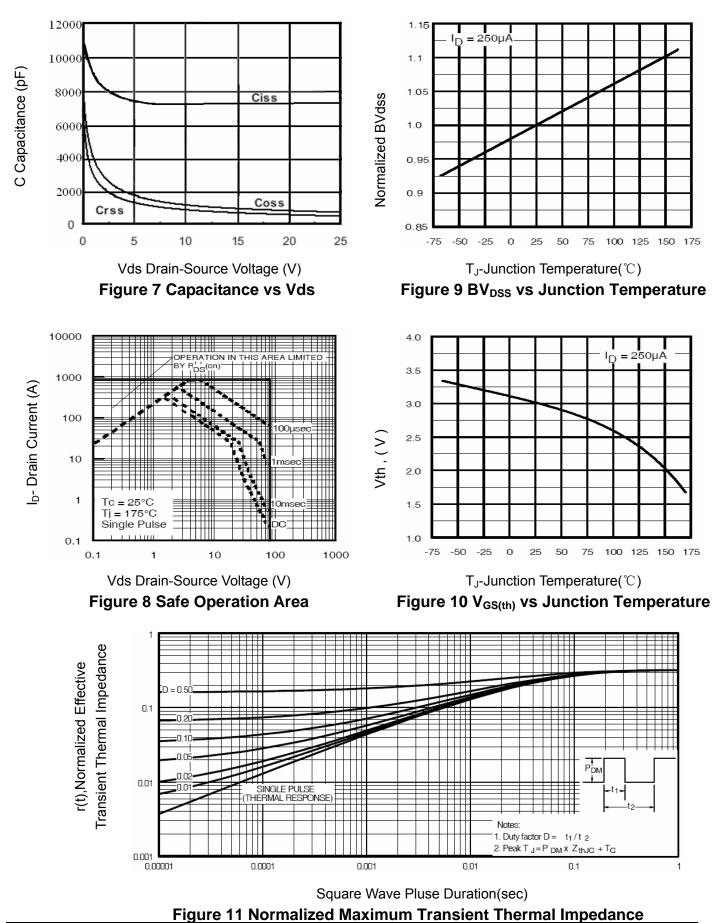


Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward

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#### **N-Ch MOSFET**

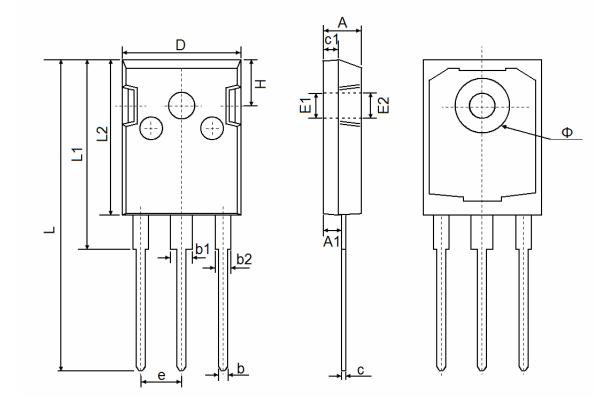




## WSL220N08

#### N-Ch MOSFET

#### **TO-247 Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.850	5. <b>150</b>			
A1	2.200	2.600			
b	1.000	1.400			
b1	2.800	3.200			
b2	1.800	2.200			
С	0.500	0.700			
c1	1.900	2.100			
D	15.4 0	15.750	0.608	0.620	
E1	3.500 REF		0.138 REF		
E2	3.600 REF		0.142 REF		
L	40.9 0	41.300	1.610	1.626	
L1	24. 0	25.100	0.976	0.988	
L2	20. 0	20.600	0.799	0.811	
Ф	7.100	7.300			
е	5.450 TYP		0.215 TYP		
Н	5.980 REF		0.235 REF		



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